### 506396215 12/10/2020

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YUNG-SYUAN LAN	08/14/2018
CHIA-WEI CHEN	08/14/2018

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17117685

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 252011-7231

NAME OF SUBMITTER: DANIEL R. MCCLURE

SIGNATURE: //Daniel R. McClure/

DATE SIGNED: 12/10/2020

**Total Attachments: 2** 

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PATENT 506396215 REEL: 054606 FRAME: 0174

# 779

#### ASSIGNMENT

WHEREAS, Yung-Syuan LAN and Chia-Wei CHEN

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: MECHANISM FOR CREATING VACUUM IN PROCESSING APPARATUS

Filed: 2018-03-29	Serial No.	15/939.383	
Executed on:			

WHEREAS, <u>Taiwan Semiconductor Manufacturing Co., Ltd.</u>, of <u>No. 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu 300-78, Taiwan R.O.C.</u>, hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

P20172310US00/0503-B32656-US

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# ASSIGNMENT

2018, 8,14	Jung-5:	ynan Lan.
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Date Name: Yung-Syuan LAN

Min- hei MAN 20 (k. k. 14.) Date

Name: Chia-Wei CHEN